#### CFP

TE Internal #: 2057629-1

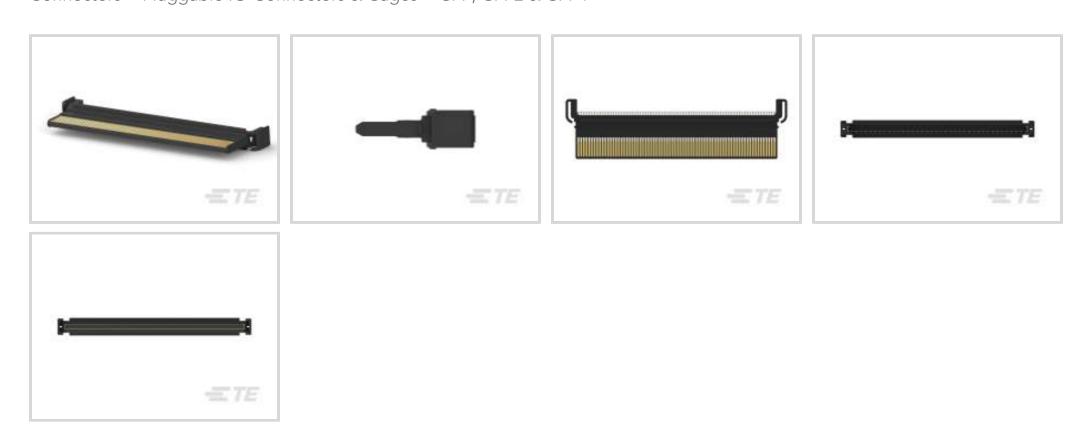
CFP, CFP2 & CFP4, Connector, 1 x 1, Data Rate (Max) 100 Gb/s, Straddle Mount Mount, Board-to-Board, 148 Position, .031 in [.8]

mm] Centerline, CFP

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > CFP, CFP2 & CFP4



Pluggable I/O Product Type: Connector

Port Matrix Configuration: 1 x 1

Data Rate (Max): 100 Gb/s

PCB Mounting Style: Straddle Mount
Connector System: Board-to-Board

## **Features**

### **Product Type Features**

Form Factor	CFP
Pluggable I/O Product Type	Connector
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 x 1
Number of Positions	148
Electrical Characteristics	
Data Rate (Max)	100 Gb/s
Body Features	
Primary Product Plating Material	Gold
Mechanical Attachment	



PCB Mounting Style	Straddle Mount
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Dimensions	
PCB Thickness (Recommended)	1.44 mm[.057 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
For Use With Pluggable I/O Products	CFP Assembly
Circuit Application	Signal
Packaging Features	
Packaging Method	Box & Tray

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
LO NOTIS Directive 2011/03/LO	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on



requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



# Also in the Series | CFP



# Customers Also Bought



TE Part #5084616-3 0.8FH,R13H.5,080,08/Sn,TR,SC



TE Part #5-5179180-5 0.8FH,R09H.5,120,08/Sn,TR,SC



TE Part #2170030-1 SFP+ 1x4 w/ Ultra Low Profile LP













TE Part #1-2308956-1 1-PORT MATENET HDR ASSY 180DEG, COD A

TE Part #2332485-1 RA REC ASSY 4X4, 92OHM PIR WHISPER R

### **Documents**

### **Product Drawings**

**CFP Module Conn Assy** 

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_2057629-1\_A.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2057629-1\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2057629-1\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

## Datasheets & Catalog Pages

CFP\_40G\_100G\_ETHERNET\_CONNECTORS

English

## **Product Specifications**

**Application Specification** 

English

**Application Specification** 

English

### **Instruction Sheets**

Instruction Sheet (U.S.)

English

Instruction Sheet (U.S.)

English